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FORM PTO-1595 RECORDAT	12-16-1999 EPARTMENT OF COMMERCE		
1/31/92 <b>PATE</b>	Patent and Trademark Office		
To the Honorable Commissioner of Patents and Tradi	101223278 hts or copy thereof.		
1, Name of conveying party(ies): JUNICHI SUGAWARA EIJI NAKASHIO SEIJI KUMAGAI YOSHITO IKEDA Additional name(s) of conveying party(ies) attached?  □ Yes ☑ No	Name and address or receiving party(ies):  Name: Sony Corporation  Internal Address:		
3 Nature of conveyance:	Street Address: 7-35, Kitashinagawa 6- Chome  Shinagawa-Ku  City: Tokyo, Japan State: Zip: Additional Name(s) & Address(es) attached Pes No		
Application (number(s) or patent number(s):  If this document is being filed together with a new app  Application No.(s)	lication, the execution date of the application is:		
A. Patent Application No.(s)	B: Patent No.(s)		
USSN 09/ 392,554 filed September 9, 1999			
Additional numbers a	attached? □ Yes ☒ No		
Name and address of party to whom correspondence concerning document should be mailed:	6 Total number of applications and patents involved1		
Hill & Simpson, P.C.  85th Floor Sears Tower 233 S. Wacker Drive Chicago, IL 60606	7 Total Fee (37 CFR 3.41		
	8. Deposit Account Number:  08-2290		
PO WOTE	(Attach duplicate copy of this page if paying by deposit account)		
DO NOT U	ISE THIS SPACE		
9. Statement and signature: To the best of my knowledge and belief, the foregoing true copy of the original document.  John Simpson Name of Person Signing  Signature	November 23, 1999  E Date  Total number of pages comprising cover sheet: 3		
Mail documents to be recorded and required cover sheet information to:  Commissioner of Patents and Trademarks  Box Assignments  Washington, D.C. 20231			

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**PATENT** 

REEL: 010432 FRAME: 0980

Docket	Number:	P99.	13	3	1
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## ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in MAGNETIC TUNNELLING ELEMENT AND MANUFACTURING METHOD THEREFOR

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filling of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 09/392,554 \_\_\_\_\_, Filing Date: 9/9/1999 \_\_\_\_.

This assignment executed on the dates indicated below.

JUNICHI SUGAWARA		
Name of first or sole inventor	Execution date of U.S. Patent Application	
MIYAGI, JAPAN		
Residence of first or sole inventor		
Junch Sugara	November 1, 1969	
Signature of first or sole inventor	Date of this assignment	

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EIJI NAKASHIO		
Name of second inventor	Execution date of U.S. Patent Application	
MIYAGI, JAPAN		
Residence of second inventor		
Fin Nearachin	Nousella 4 1000	
Signature of second inventor	Nowing 4, 1999, Date of this assignment	
SEIJI KUMAGAI		
Name of third inventor	Execution date of U.S. Patent Application	
MIYAGI, JAPAN		
Residence of third inventor		
San Kain Gu	Nevember 4 1996	
Signature of third inventor	Neveriber 4, 1999  Date of this assignment	
YOSHITO IKEDA  Name of fourth inventor		
Name of fourth inventor	Execution date of U.S. Patent Application	
TOCHIGI, JAPAN		
Residence of fourth inventor		
Signature of fourth inventor	November 8 1999	
Signature of fourth inventor	November 8, 1999  Date of this assignment	
Name of fifth inventor	Execution date of U.S. Patent Application	
Residence of fifth inventor		
Signature of fifth inventor	Date of this assignment	
	Date of this assignment	

PATENT RECORDED: 11/30/1999 REEL: 010432 FRAME: 0982